# 2SK1305

## Silicon N-Channel MOS FET

# **HITACHI**

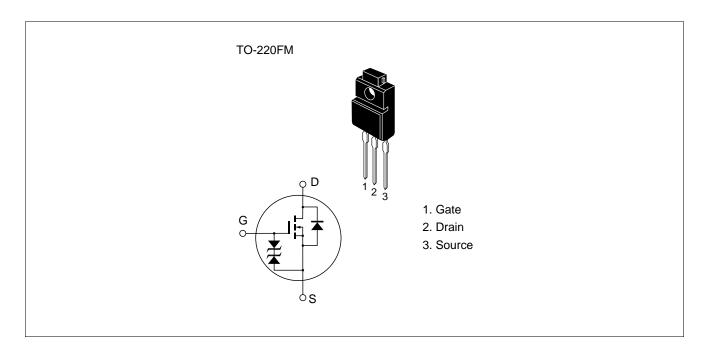
### **Application**

High speed power switching

#### **Features**

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device
  - Can be driven from 5 V source
- Suitable for motor drive, DC-DC converter, power switch and solenoid drive

### **Outline**





### 2SK1305

### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{\scriptscriptstyle DSS}$	100	V
Gate to source voltage	$V_{\sf GSS}$	±20	V
Drain current	I <sub>D</sub>	10	A
Drain peak current	I <sub>D(pulse)</sub> *1	40	Α
Body to drain diode reverse drain current	I <sub>DR</sub>	10	А
Channel dissipation	Pch*2	25	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

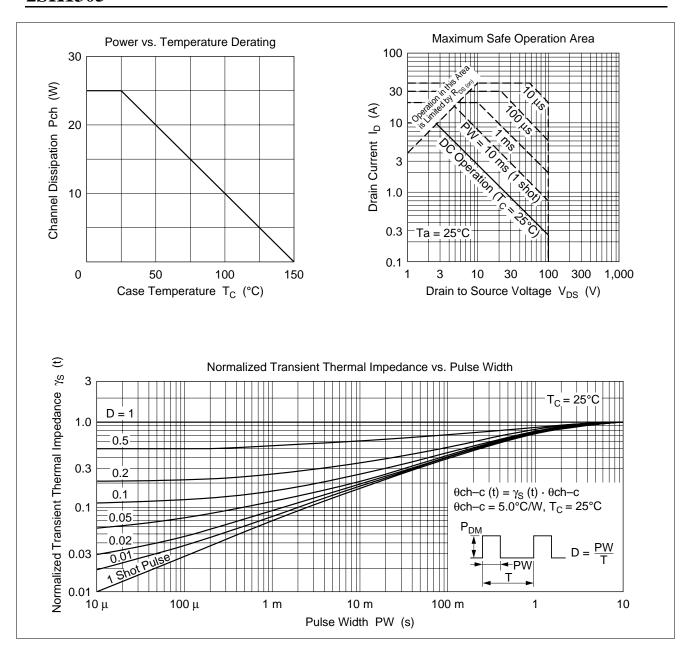
2. Value at  $T_c = 25^{\circ}C$ 

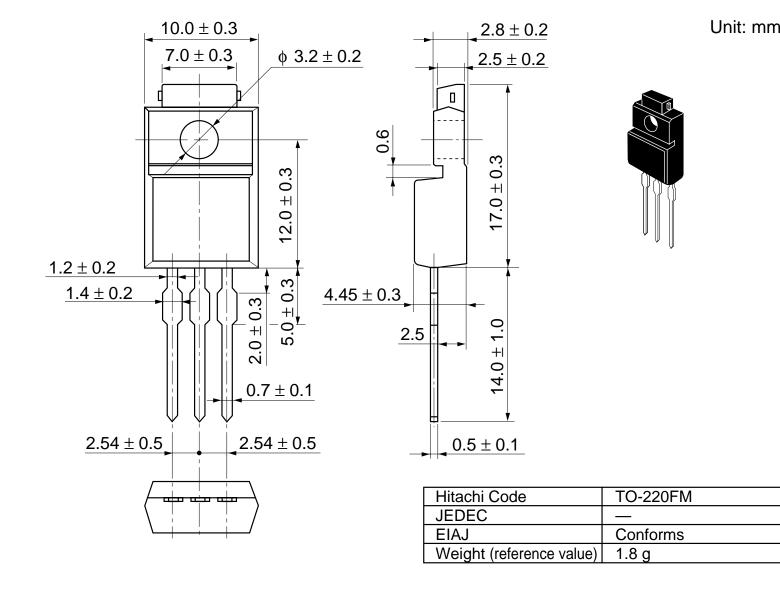
## Electrical Characteristics ( $Ta = 25^{\circ}C$ )

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	100	_	_	V	$I_{D} = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	250	μΑ	$V_{DS} = 80 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	1.0	_	2.0	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	R <sub>DS(on)</sub>	_	0.20	0.25	Ω	$I_D = 5 \text{ A}, V_{GS} = 10 \text{ V}^{*1}$
		_	0.25	0.35	Ω	$I_D = 5 \text{ A}, V_{GS} = 4 \text{ V}^{*1}$
Forward transfer admittance	yfs	4.5	7.0	_	S	$I_D = 5 \text{ A}, V_{DS} = 10 \text{ V}^{*1}$
Input capacitance	Ciss	_	525	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	205	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	60	_	pF	<del></del>
Turn-on delay time	t <sub>d(on)</sub>	_	5	_	ns	$I_D = 5 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	t <sub>r</sub>	_	50	_	ns	$R_L = 6 \Omega$
Turn-off delay time	t <sub>d(off)</sub>	_	170	_	ns	<del></del>
Fall time	t <sub>f</sub>	_	75	_	ns	
Body to drain diode forward voltage	$V_{DF}$	_	1.2	_	V	$I_F = 10 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	_	220	_	ns	$I_F = 10 \text{ A}, V_{GS} = 0,$ $di_F/dt = 50 \text{ A}/\mu\text{s}$
Note: 4 Dules test						

Note: 1. Pulse test

See characteristic curves of 2SK1300.





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